BYW29F series

GENERAL DESCRIPTION

Glass passivated high efficiency rectifier diodes in full pack, plastic envelopes, featuring low forward voltage drop, ultra-fast recovery times and soft recovery characteristic. They are intended for use in switched mode power supplies and high frequency circuits in general

where low conduction and switching

QUICK REFERENCE DATA

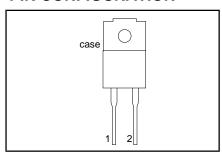
SYMBOL	PARAMETER	MAX.	MAX.	MAX.	UNIT
V _{RRM}	BYW29F- Repetitive peak reverse voltage	100 100	150 150	200 200	V
V _F I _{F(AV)} t _{rr}	Forward voltage Forward current Reverse recovery time	0.895 8 25	0.895 8 25	0.895 8 25	V A ns

PINNING - SOD100

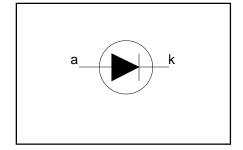
losses are essential.

PIN	DESCRIPTION	
1	cathode	
2	anode	
case	isolated	

PIN CONFIGURATION



SYMBOL



LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT	
V _{RRM} V _{RWM} V _R	Repetitive peak reverse voltage Crest working reverse voltage Continuous reverse voltage		1 1 1	-100 100 100 100	-150 150 150 150	-200 200 200 200	>>>
I _{F(AV)}	Average forward current ²	square wave; $\delta = 0.5$; $T_{hs} \le 106 ^{\circ}C$	-		8		А
		sinusoidal; a = 1.57; T _{bs} ≤ 109 °C	-		7.3		Α
I _{F(RMS)}	RMS forward current		-		11.3		Α
I _{FRM}	Repetitive peak forward current	$t = 25 \mu s; \delta = 0.5;$ $T_{hs} \le 109 ^{\circ}C$	-		16		Α
I _{FSM}	Non-repetitive peak forward	t = 10 ms	-		80		Α
	current	t = 8.3 ms sinusoidal; with reapplied	-		88		Α
l ² t	I ² t for fusing	$V_{RWM(max)}$ t = 10 ms	_		32		A ² s
1 🛨	Storage temperature	- 10 1115	-40		150		Ç
T_{j}^{stg}	Operating junction temperature		-		150		ο̈́ο

¹ $T_{hs} \le 141$ °C for thermal stability.

² Neglecting switching and reverse current losses

Philips Semiconductors Product specification

Rectifier diodes ultrafast

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ISOLATION

 T_{hs} = 25 °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{isol}	Repetitive peak voltage from both terminals to external heatsink	R.H. ≤ 65% ; clean and dustfree	ı	-	1500	V
C _{isol}	Capacitance from cathode to external heatsink	f = 1 MHz	-	12	-	pF

THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{\text{th } j\text{-hs}}$ $R_{\text{th } j\text{-a}}$	mounting base	with heatsink compound without heatsink compound in free air		- - 55	5.5 7.2 -	K/W K/W K/W

STATIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

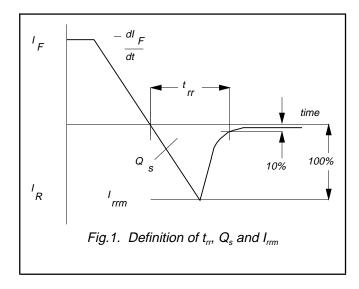
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V_{F}	Forward voltage	$I_F = 8 \text{ A}; T_i = 150^{\circ}\text{C}$	-	0.80	0.895	V
	_	$I_F = 8 \text{ A}$	-	0.92	1.05	V
		$I_{\rm F} = 20 \text{ A}$	-	1.1	1.3	V
I _R	Reverse current	$\dot{V}_R = V_{RWM}$; $T_i = 100 ^{\circ}C$	-	0.3	0.6	mΑ
		$V_R = V_{RWM}$	-	2	10	μΑ

DYNAMIC CHARACTERISTICS

T_i = 25 °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Q_s	Reverse recovery charge	$I_{E} = 2 \text{ A}; V_{R} \ge 30 \text{ V}; -dI_{E}/dt = 20 \text{ A/}\mu\text{s}$	-	4	11	nC
t _{rr}		$I_{F} = 1 \text{ A}; V_{R} \ge 30 \text{ V};$	-	20	25	ns
		$-dI_F/dt = 100 A/\mu s$				
I _{rrm}	Peak reverse recovery current	$I_F = 10 \text{ A}; V_R \ge 30 \text{ V}; T_j = 100 \text{ °C};$	-	1	2	Α
l . ,		-dI _F /dt = 50 A/μs				
V_{fr}	Forward recovery voltage	$I_F = 1 \text{ A}$; $dI_F/dt = 10 \text{ A/}\mu\text{s}$	-	1	-	V

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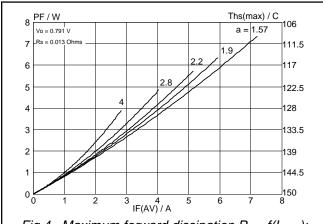
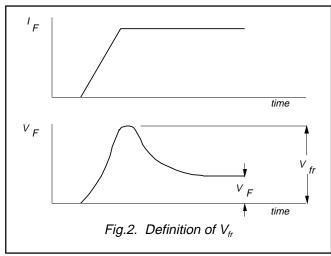
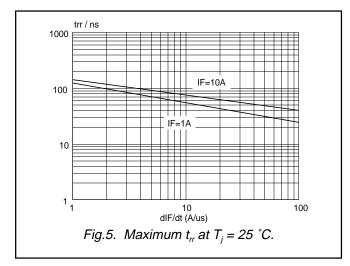
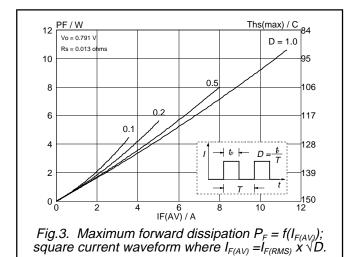
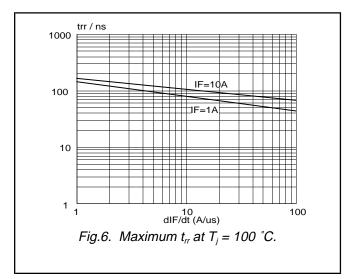


Fig.4. Maximum forward dissipation $P_F = f(I_{F(AV)})$; sinusoidal current waveform where a = form factor $= I_{F(RMS)} / I_{F(AV)}$.

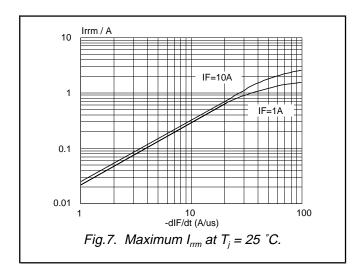


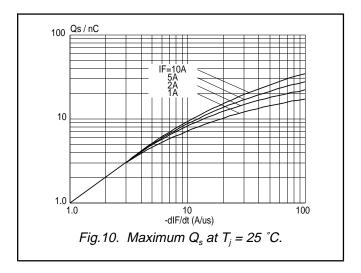


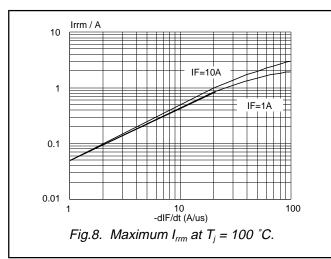


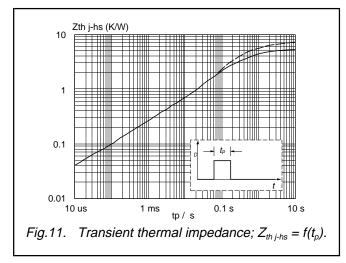


BYW29F series









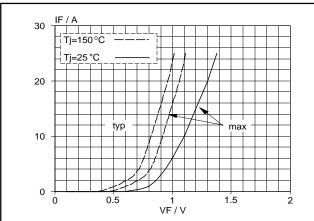
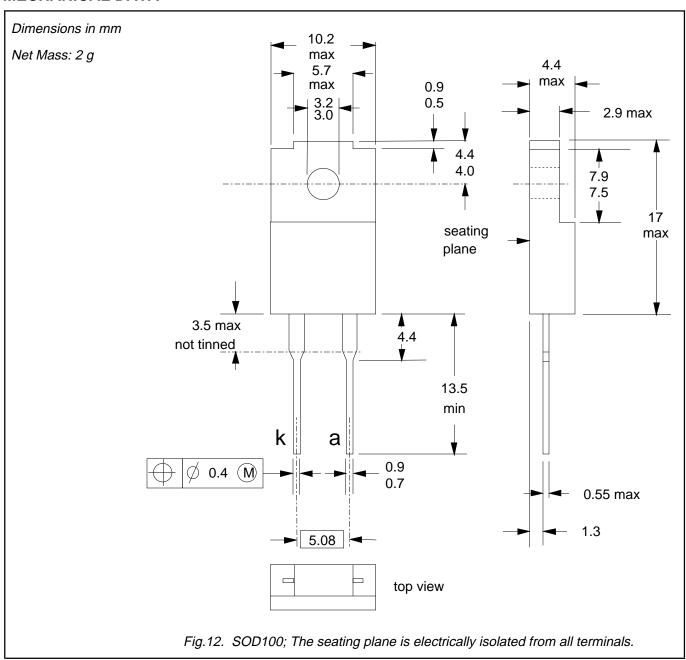


Fig.9. Typical and maximum forward characteristic $I_F = f(V_F)$; parameter T_j

BYW29F series

MECHANICAL DATA



- Accessories supplied on request: refer to mounting instructions for F-pack envelopes.
 Epoxy meets UL94 V0 at 1/8".

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DEFINITIONS

Data sheet status				
Objective specification	This data sheet contains target or goal specifications for product development.			
Preliminary specification This data sheet contains preliminary data; supplementary data may be published late				
Product specification	This data sheet contains final product specifications.			

Limiting values

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

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